DATA SHEET

SKY73087-11: 700 – 1000 MHz High Gain and Linearity Diversity Downconversion Mixer

Applications

- 2G/3G base station transceivers:
  - GSM/EDGE, CDMA, UMTS/WCDMA
- Land mobile radio
- High performance radio links

Features

- Operating frequency range: 700 to 1000 MHz
- IF frequency range: 100 to 500 MHz
- Conversion gain: 8.8 dB
- Input IP3: +25.3 dBm
- Output IP3: +34.1 dBm
- Noise figure: 10.7 dB
- Integrated LO drivers
- Integrated low loss RF baluns
- High linearity IF amplifiers
- On-chip SPDT LO switch (greater than 60 dB LO-to-LO isolation)
- Small, MCM (36-pin, 6 x 6 mm) package (MSL3, 260 °C per JEDEC J-STD-020)

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Description

The SKY73087-11 is a fully integrated diversity mixer that includes Local Oscillator (LO) drivers, an LO switch, high linearity mixers, and large dynamic range Intermediate Frequency (IF) amplifiers. Low loss RF baluns have also been included to reduce design complications and lower system cost.

The SKY73087-11 features an input IP3 of +25.3 dBm and a Noise Figure (NF) of 10.7 dB, making the device an ideal solution for high dynamic range systems such as 2G/3G base station receivers. The LO switch provides more than 57 dB of isolation between LO inputs and supports the switching time required for GSM/EDGE base stations.

The SKY73087-11 is manufactured using a robust silicon BiCMOS process and has been designed for optimum long-term reliability. The SKY73087-11 diversity downconversion mixer is provided in a compact, 36-pin Multi-Chip Module (MCM). A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

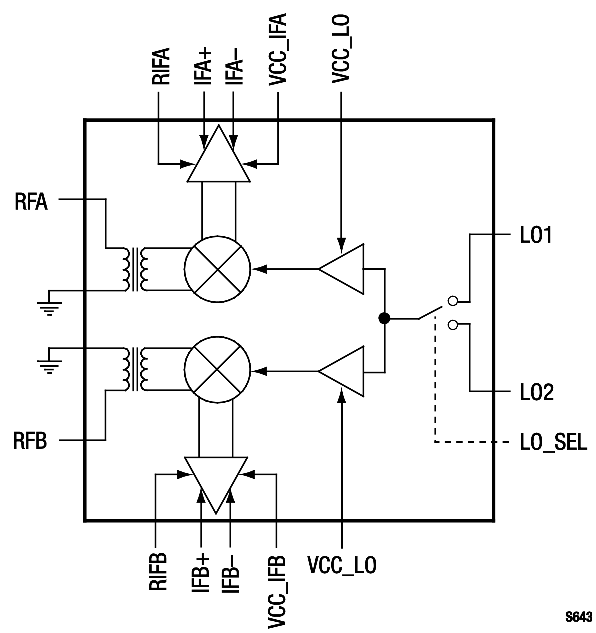


Figure 1. SKY73087-11 Block Diagram

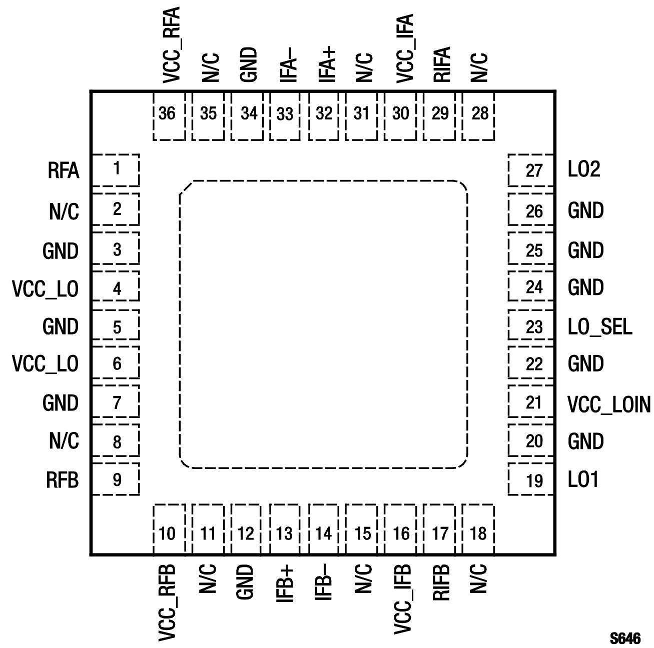


Figure 2. SKY73087-11 Pinout – 36-Pin MCM (Top View)

Table 1. SKY73087-11 Signal Descriptions

Pin #	Name	Description	Pin #	Name	Description
1	RFA	RF channel A input	19	LO1	Local oscillator #1 input
2	N/C	No connect	20	GND	Ground
3	GND	Ground	21	VCC_LOIN	DC supply, +5 V
4	VCC_LO	DC supply, +5 V	22	GND	Ground
5	GND	Ground	23	LO_SEL	Local oscillator switch select
6	VCC_LO	DC supply, +5 V	24	GND	Ground
7	GND	Ground	25	GND	Ground
8	N/C	No connect	26	GND	Ground
9	RFB	RF channel B input	27	LO2	Local oscillator #2 input
10	VCC_RFB	DC supply, +5 V	28	N/C	No connect
11	N/C	No connect	29	RIFA	IF channel A bias control
12	GND	Ground	30	VCC_IFA	DC supply, +5 V
13	IFB+	IF channel B positive output	31	N/C	No connect
14	IFB–	IF channel B negative output	32	IFA+	IF channel A positive output
15	N/C	No connect	33	IFA–	IF channel A negative output
16	VCC_IFB	DC supply, +5 V	34	GND	Ground
17	RIFB	IF channel B bias control	35	N/C	No connect
18	N/C	No connect	36	VCC_RFA	DC supply, +5 V

Functional Description

The SKY73087-11 is a high gain diversity mixer, optimized for base station receiver applications. The device consists of two diversity channels, each consisting of a low loss RF balun, high linearity passive mixer, and a low noise IF amplifier.

LO amplifiers are also included that allow the SKY73087-11 to connect directly to the output of a Voltage Controlled Oscillator (VCO). This eliminates the extra gain stages needed by most discrete passive mixers. A Single Pole, Double Throw (SPDT) switch has been included to select between two different LO inputs for frequency hopping applications (i.e., GSM).

RF Baluns and Passive Mixer

The RF baluns provide a single ended input, which can easily be matched to 50 Ω using a simple matching circuit. The RF baluns offer very low loss and excellent amplitude and phase balance.

The high linearity mixer is a passive, double balanced mixer that provides a very low insertion loss, and excellent 3rd Order Input Insertion Point (IIP3) and linearity performance.

Additionally, the balanced nature of the mixer provides for excellent port-to-port isolation.

LO Buffers and SPDT LO Switch

The LO buffers allow the input power of the SKY73087-11 to be programmed in the range of –6 to +6 dBm. The LO section has been optimized for high-side LO injection. However, the LO can be driven over a wide frequency range with only slight degradation in performance.

A high isolation SPDT switch allows the SKY73087-11 to be used for frequency hopping applications. This switch provides greater than 57 dB of LO1 to LO2 isolation:

LO_SEL Logic:	State:
High	LO1 enabled
Low	LO2 enabled

For applications that do not require frequency hopping, LO_SEL is fixed to one state and the appropriate LO input is used.

IF Amplifier

The SKY73087-11 includes high dynamic range IF amplifiers that follow the passive mixers in the signal path. The outputs require a supply voltage connection using inductive chokes. These choke inductors should be high-Q and have the ability to handle 200 mA or greater.

A simple matching network allows the output ports to be matched to a balanced 200 Ω impedance. The IF amplifiers are optimized for IF frequencies between 100 and 500 MHz. The IF amplifiers can be operated outside of this range, but with a slight degradation in performance.

Electrical and Mechanical Specifications

The absolute maximum ratings of the SKY73087-11 are provided in Table 2. The recommended operating conditions are specified in Table 3 and electrical specifications are provided in Table 4. Spurious performance measurements for the 3GPP bands #20, 8, and 5 are listed in Tables 5, 6, and 7, respectively.

Typical performance characteristics of the SKY73087-11 are illustrated in Figures 3 through 43.

Table 2. SKY73087-11 Absolute Maximum Ratings

Parameter	Symbol	Minimum	Typical	Maximum	Units
Supply voltage, +5 V (VCC_LO, VCC_RFB, VCC_IFB, VCC_LOIN, VCC_IFA, VCC_RFA)	VCC	4.5	5.0	5.5	V
Supply current	I_{CC}		370	430	mA
RF input power	P_{RF}			+20	dBm
LO input power	P_{LO}		0	+20	dBm
Operating case temperature	T_C	–40		+85	°C
Junction temperature	T_J			+150	°C
Storage case temperature	T_{STG}	–40		+150	°C

Notes: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

Nominal thermal resistance (junction to center ground pad) is 5.1 °C/W.

***CAUTION**: Although this device is designed to be as robust as possible, Electrostatic Discharge (ESD) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times.*

Table 3. SKY73087-11 Recommended Operating Conditions (Note 1)

Parameter	Symbol	Minimum	Typical	Maximum	Units
Supply voltage, +5 V ((VCC_LO, VCC_RFB, VCC_IFB, VCC_LOIN, VCC_IFA, VCC_RFA)	VCC	4.75	5.00	5.25	V
Supply current	I_{CC}		370		mA
RF frequency range	F_{RF}	700		1000	MHz
LO frequency range (Note 1)	F_{LO}	800		1500	MHz
IF frequency range	F_{IF}	100		500	MHz
LO input power	P_{LO}	–6	0	+6	dBm
LO select logic: high low	 LO_SEL_H LO_SEL_L	 2.2 		 0.8	 V V
Operating case temperature	T_C	–40		+85	°C

Note 1: The SKY73087-11 has been optimized for high-side LO injection. However, the LO can be used outside of the specified frequency range with degraded performance.

Table 4. SKY73087-11 Electrical Specifications (Note 1)
(Voltage Supply = +5 V, T_C = +25 °C, LO = 0 dBm, RF Frequency = 900 MHz, IF Frequency = 350 MHz, LO Frequency = 1250 MHz, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
Conversion gain	G	F_{RF} = 824 to 940 MHz, VCC = 4.75 to 5.25 V, P_{LO} = –3 to +3 dBm	8.3	8.8		dB
Noise Figure	NF	F_{RF} = 900 MHz		10.7	12.2	dB
Noise Figure with a blocker signal	NF_{BLK}	Blocking signal input power = +8 dBm		20.5	25.0	dB
Third order input intercept point	IIP3	F_{RF} = 900 and 900.8 MHz, P_{RF} = –10 dBm/each tone, VCC = 4.75 to 5.25 V, P_{LO} = –3 to +3 dBm	+23.5	+25.3		dBm
2RF – 2LO	2x2	P_{RF} = –10 dBm		–62	–53	dBc
3RF – 3LO	3x3	P_{RF} = –10 dBm		–75	–65	dBc
Input 1 dB compression point	IP1dB			+12.7		dBm
LO1 to LO2 isolation			40	57		dB
Channel-to-channel isolation			37	42		dB
RF to IF isolation			30	47		dB
LO leakage: 1xLO to RF port 2xLO to RF port 3xLO to RF port 4xLO to RF port 1xLO to IF port				 –36 –25 –71 –73 –40	 –25 –20 –28 –28 –23	 dBm dBm dBm dBm dBm
LO_SEL input			–20	+150	+250	μA
LO switching time					1.0	μs
RF port input return loss	Z_{IN_RF}	With external matching components	14			dB
LO port input return loss	Z_{IN_LO}	With external matching components	14			dB
IF port input return loss	Z_{OUT_IF}	With external matching components	14			dB

Note 1: Performance is guaranteed only under the conditions listed in this Table.

Table 5. SKY73087-11 Spurious Suppression Measurements, 3GPP Band #20 (Note 1)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
2RF – 1LO	2x1	P_{RF} = –10 dBm		–50	–45	dBc
4RF – 3LO	4x3	P_{RF} = 0 dBm		–89	–85	dBc
6RF – 4LO	6x4	P_{RF} = 0 dBm		–110	–85	dBc
7RF – 5LO	7x5	P_{RF} = 0 dBm		–115	–85	dBc
8RF – 6LO	8x6	P_{RF} = 0 dBm		–114	–85	dBc
9RF –6LO	9x6	P_{RF} = 0 dBm		–111	–85	dBc
10RF – 7LO	10x7	P_{RF} = 0 dBm		–107	–85	dBc

Note 1: Performance is guaranteed only under the conditions listed in this Table.

Table 6. SKY73087-11 Spurious Suppression Measurements, 3GPP Band #8 (Note 1)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
4RF – 3LO	4x3	P_{RF} = –3 dBm		–86	–80	dBc
5RF – 4LO	5x4	P_{RF} = –1.5 dBm		–102	–95	dBc
6RF – 4LO	6x4	P_{RF} = 0 dBm		–109	–95	dBc
8RF – 6LO	8x6	P_{RF} = 0 dBm		–114	–95	dBc
9RF – 6LO	9x6	P_{RF} = +8.5 dBm		–112	–95	dBc
10RF –7LO	10x7	P_{RF} = +7.5 dBm		–103	–95	dBc
11RF – 8LO	11x8	P_{RF} = +9 dBm		–108	–95	dBc
12RF – 8LO	12x8	P_{RF} = +10 dBm		–109	–95	dBc
12RF – 9LO	12x9	P_{RF} = +8.5 dBm		–102	–95	dBc
13RF – 9LO	13x9	P_{RF} = 0 dBm		–122	–95	dBc
14RF – 10LO	14x10	P_{RF} = +9 dBm		–118	–95	dBc
15RF – 10LO	15x10	P_{RF} = +11.5 dBm		–115	–95	dBc
15RF – 11LO	15x11	P_{RF} = 0 dBm		–119	–95	dBc
16RF – 11LO	16x11	P_{RF} = +11.5 dBm		–112	–95	dBc
16RF – 12LO	16x12	P_{RF} = +11 dBm		–108	–95	dBc
17RF – 12LO	17x12	P_{RF} = +11.5 dBm		–117	–95	dBc
18RF – 13LO	18x13	P_{RF} = +12 dBm		–109	–95	dBc
19RF – 13LO	19x13	P_{RF} = +12 dBm		–116	–95	dBc
20RF – 14LO	20x14	P_{RF} = +12 dBm		–114	–95	dBc
21RF – 15LO	21x15	P_{RF} = +12 dBm		–118	–95	dBc
22RF – 15LO	22x15	P_{RF} = +12 dBm		–121	–95	dBc
23RF – 17LO	23x17	P_{RF} = +12 dBm		–127	–95	dBc

Note 1: Performance is guaranteed only under the conditions listed in this Table.

Table 7. SKY73087-11 Spurious Suppression Measurements, 3GPP Band #5 (Note 1)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
2RF – 1LO	2x1	P_{RF} = –10 dBm		–48	–45	dBc
4RF – 3LO	4x3	P_{RF} = +5 dBm		–80	–95	dBc
6RF – 4LO	6x4	P_{RF} = +5 dBm		–108	–95	dBc
7RF – 5LO	7x5	P_{RF} = +5 dBm		–102	–95	dBc
8RF – 6LO	8x6	P_{RF} = +5 dBm		–108	–95	dBc
9RF –6LO	9x6	P_{RF} = +5 dBm		–116	–95	dBc

Note 1: Performance is guaranteed only under the conditions listed in this Table.

Typical Performance Characteristics

(Voltage Supply = +5 V, T_C = +25 °C, LO = 0 dBm, RF Frequency = 900 MHz, IF Frequency = 350 MHz, LO Frequency = 1250 MHz, Unless Otherwise Noted)

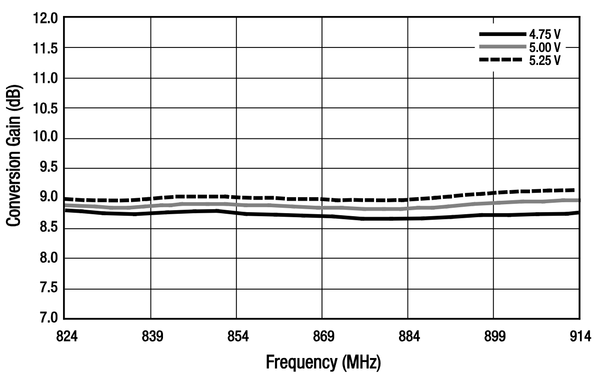


Figure 3. Mixer A Conversion Gain vs Frequency and Supply Voltage

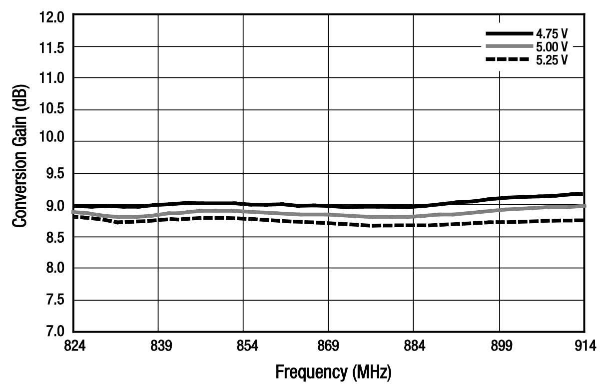


Figure 4. Mixer B Conversion Gain vs Frequency and Supply Voltage

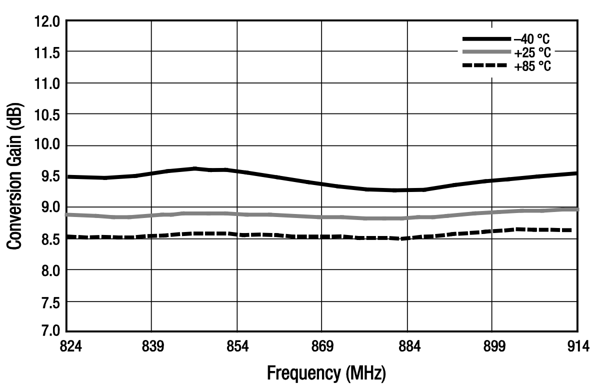


Figure 5. Mixer A Conversion Gain vs Frequency and Temperature

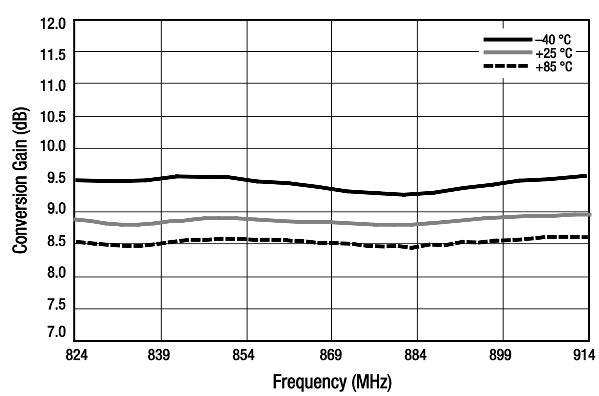


Figure 6. Mixer B Conversion Gain vs Frequency and Temperature

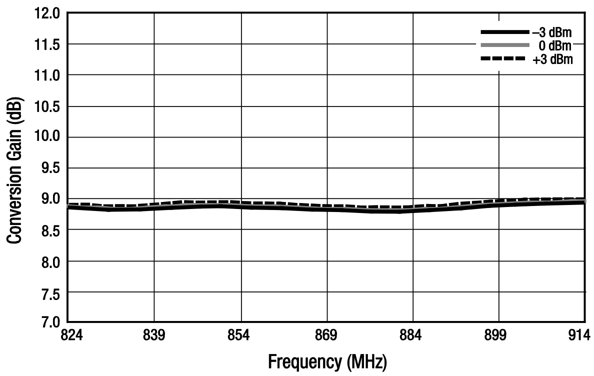


Figure 7. Mixer A Conversion Gain vs Frequency and LO Power

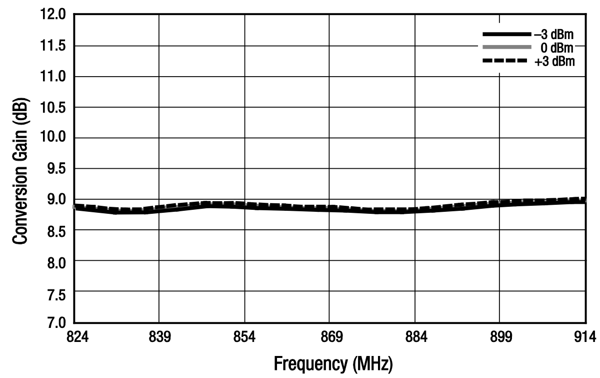


Figure 8. Mixer B Conversion Gain vs Frequency and LO Power

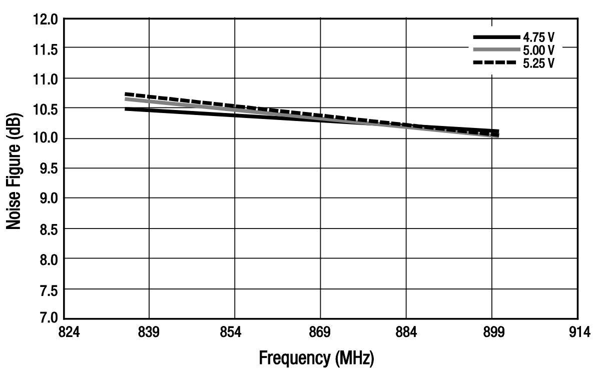


Figure 9. Mixer A Noise Figure vs Frequency and Supply Voltage

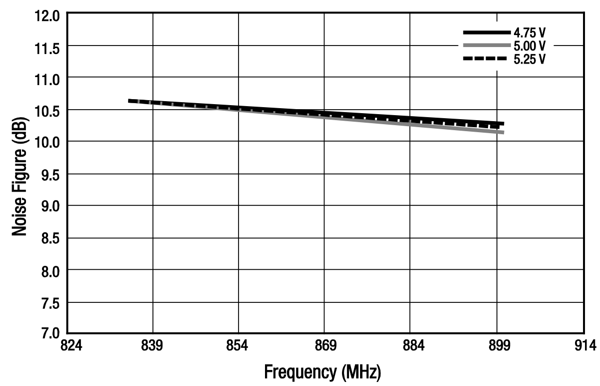


Figure 10. Mixer B Noise Figure vs Frequency and Supply Voltage

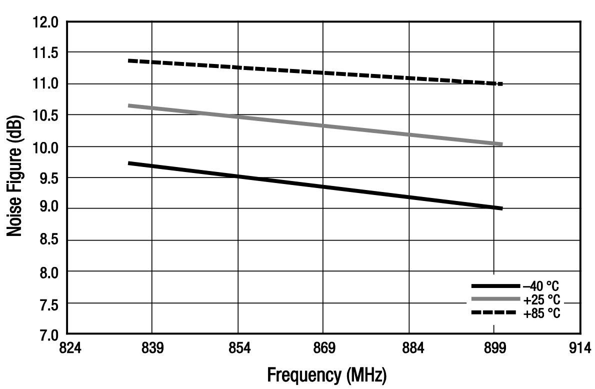


Figure 11. Mixer A Noise Figure vs Frequency and Temperature

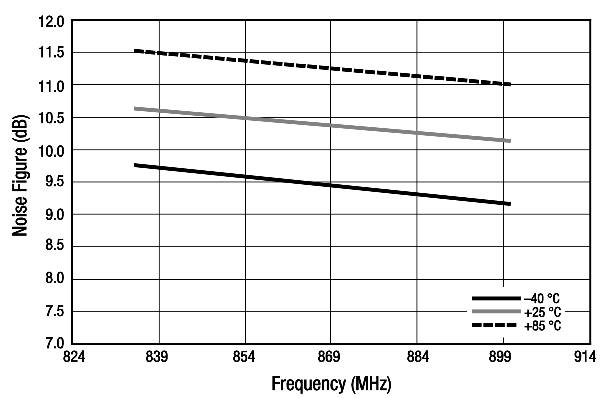


Figure 12. Mixer B Noise Figure vs Frequency and Temperature

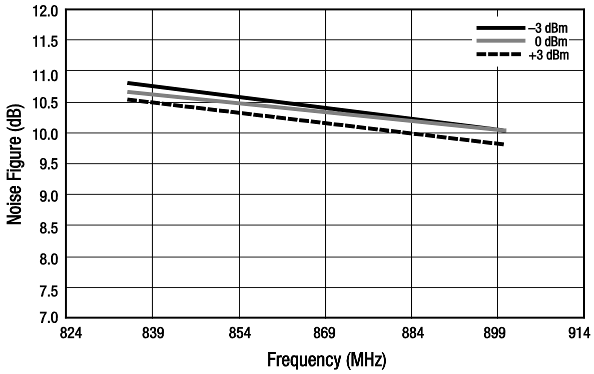


Figure 13. Mixer A Noise Figure vs Frequency and LO Power

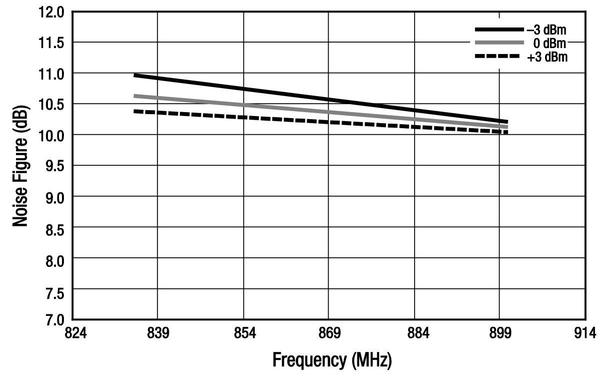


Figure 14. Mixer B Noise Figure vs Frequency and LO Power

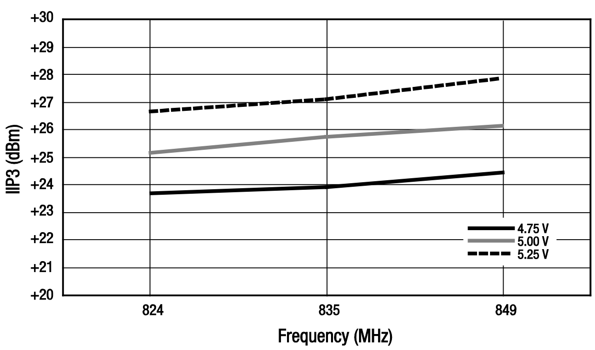


Figure 15. Mixer A GSM850 Band IIP3 vs Frequency and Supply Voltage

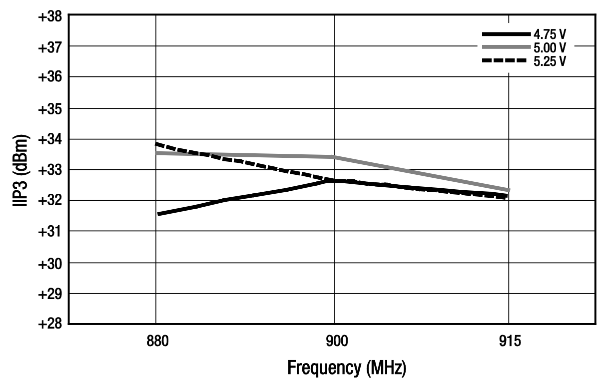


Figure 16. Mixer A EGSM900 Band IIP3 vs Frequency and Supply Voltage

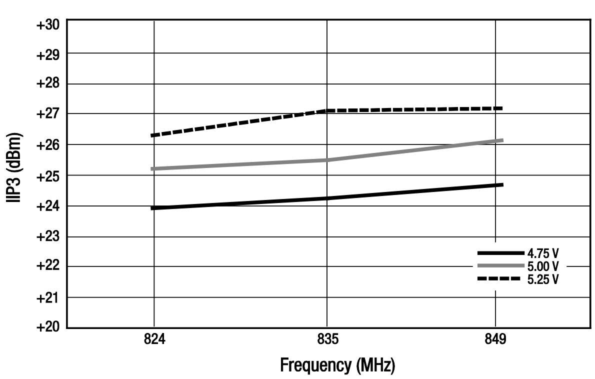


Figure 17. Mixer B GSM850 Band IIP3 vs Frequency and Supply Voltage

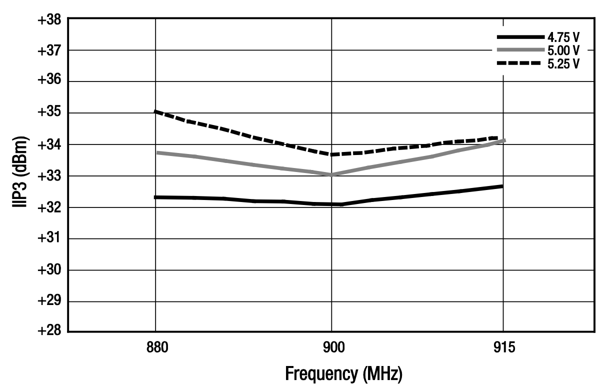


Figure 18. Mixer B EGSM900 Band IIP3 vs Frequency and Supply Voltage

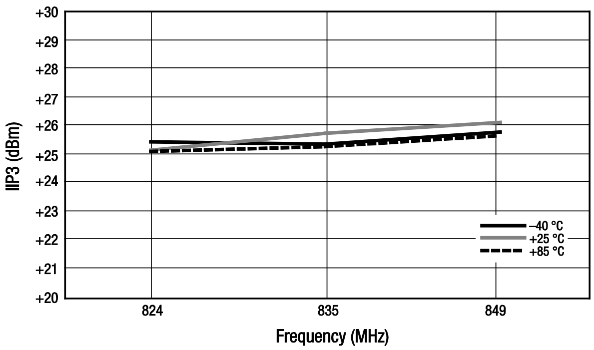


Figure 19. Mixer A GSM850 Band IIP3 vs Frequency and Temperature

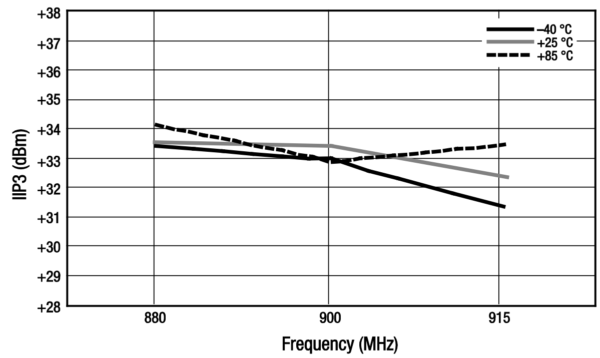


Figure 20. Mixer A EGSM900 Band IIP3 vs Frequency and Temperature

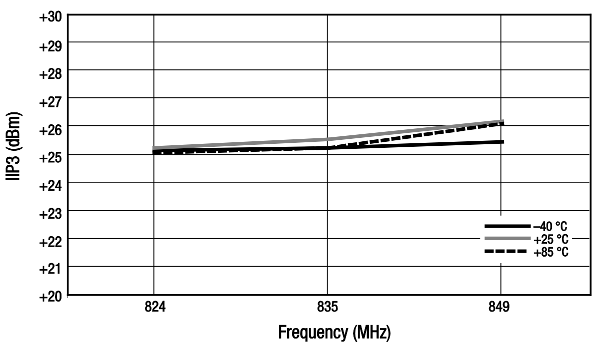


Figure 21. Mixer B GSM850 Band IIP3 vs Frequency and Temperature

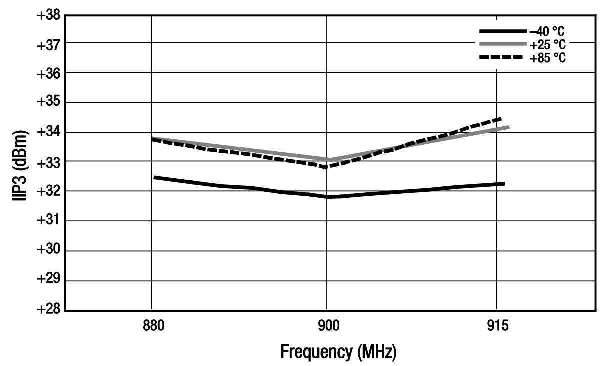


Figure 22. Mixer B EGSM900 Band IIP3 vs Frequency and Temperature

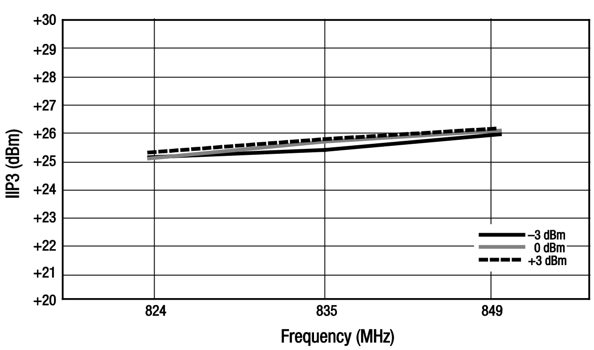


Figure 23. Mixer A GSM850 Band IIP3 vs Frequency and LO Power

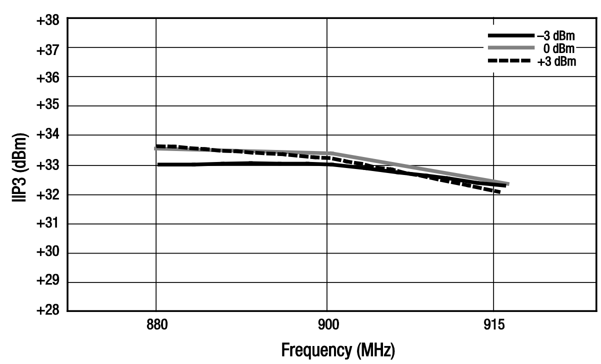


Figure 24. Mixer A EGSM900 Band IIP3 vs Frequency and LO Power

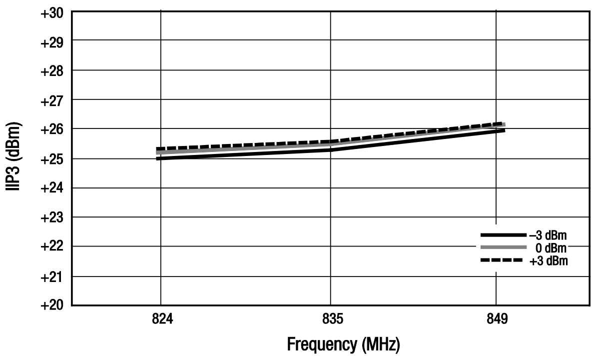


Figure 25. Mixer B GSM850 Band IIP3 vs Frequency and LO Power

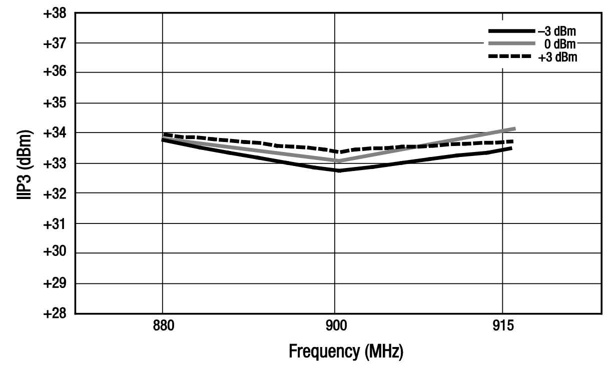


Figure 26. Mixer B EGSM900 Band IIP3 vs Frequency and LO Power

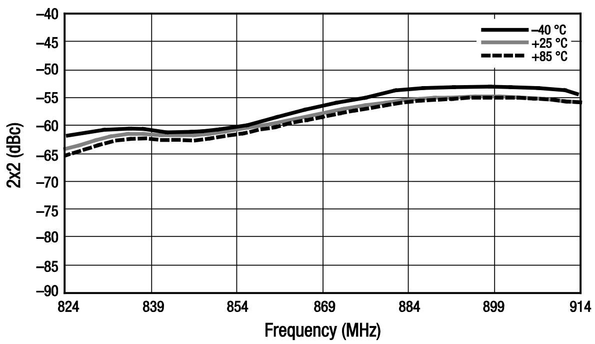


Figure 27. Mixer A 2RF–2LO vs Frequency and Temperature

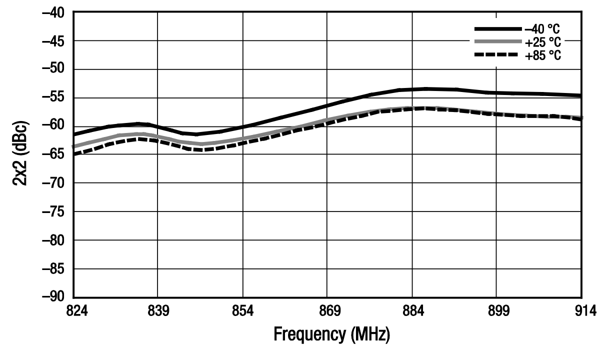


Figure 28. Mixer B 2RF–2LO vs Frequency and Temperature

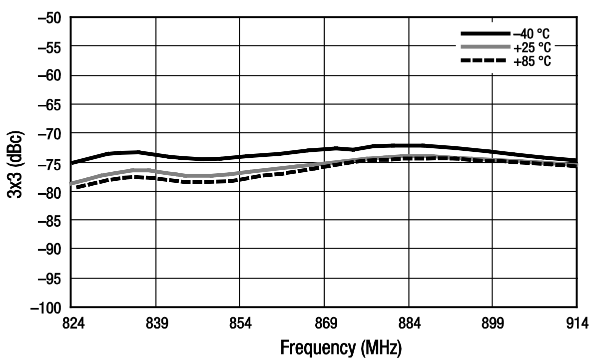


Figure 29. Mixer A 3RF–3LO vs Frequency and Temperature

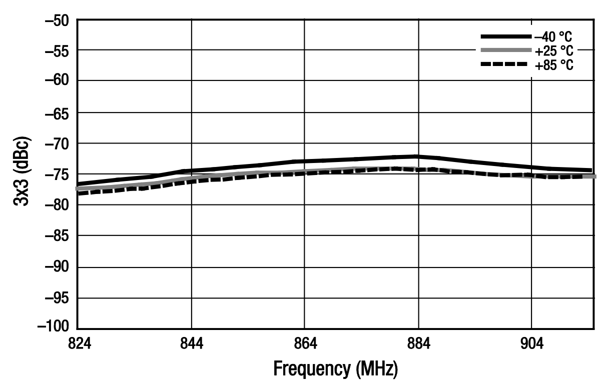


Figure 30. Mixer B 3RF–3LO vs Frequency and Temperature

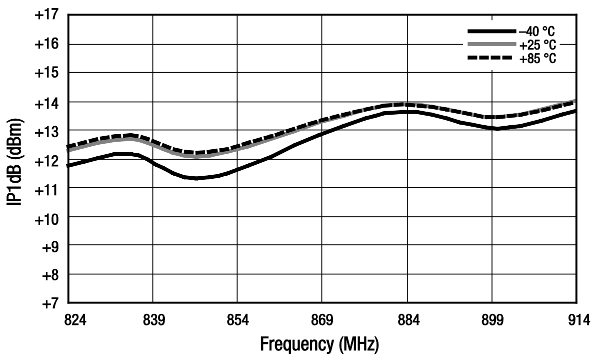


Figure 31. Mixer A IP1dB vs Frequency and Temperature

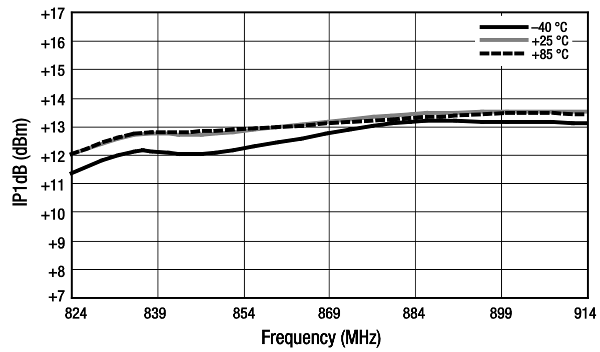


Figure 32. Mixer B IP1dB vs Frequency and Temperature

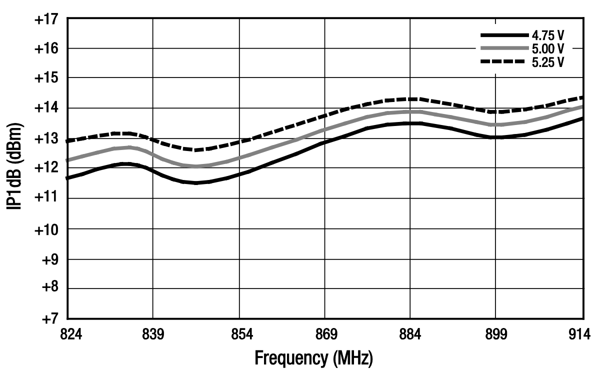


Figure 33. Mixer A IP1dB vs Frequency and Supply Voltage

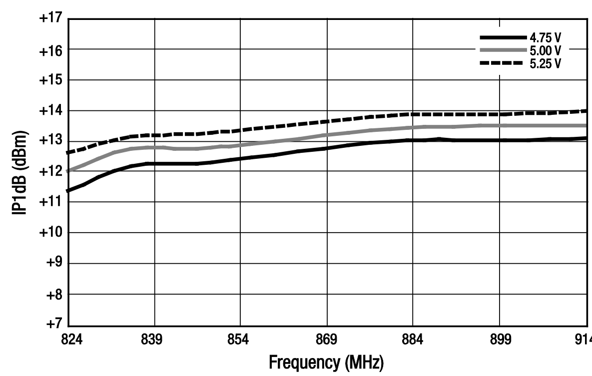


Figure 34. Mixer B IP1dB vs Frequency and Supply Voltage

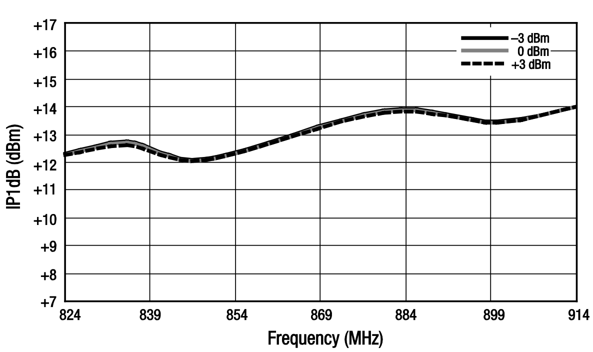


Figure 35.Mixer A IP1dB vs Frequency and LO Power

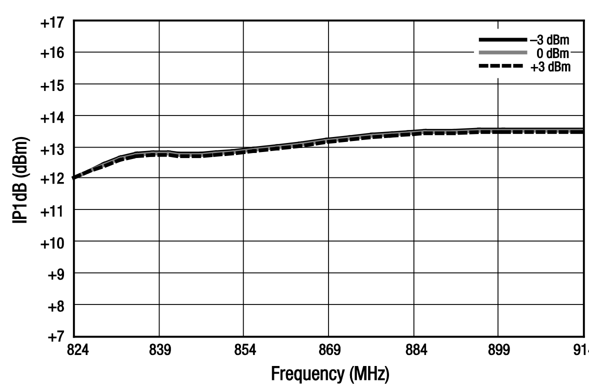


Figure 36. Mixer B IP1dB vs Frequency and LO Power

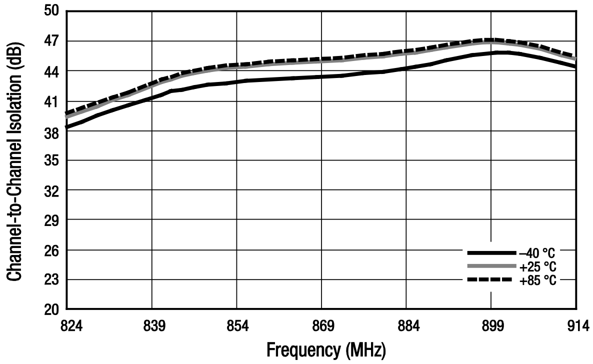


Figure 37. Mixer A & B Channel-to-Channel Isolation vs Frequency and Temperature

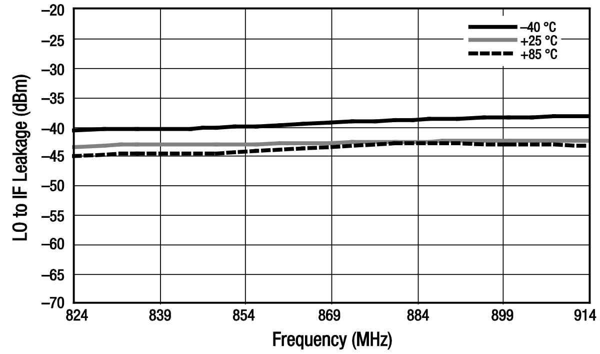


Figure 38. Mixer A LO to IF Leakage vs Frequency and Temperature

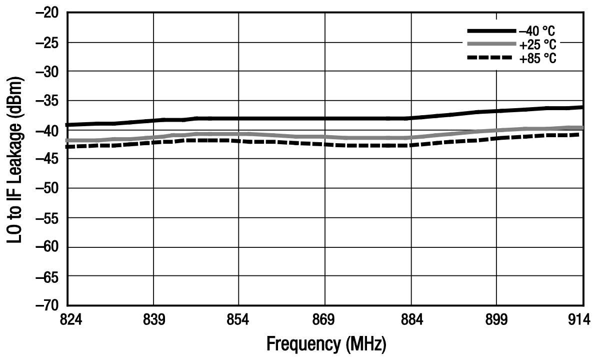


Figure 39. Mixer B LO to IF Leakage vs Frequency and Temperature

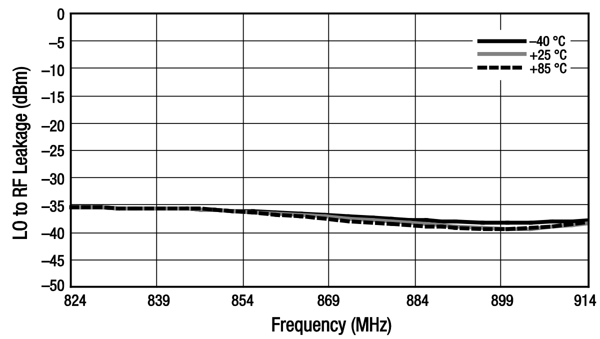


Figure 40. Mixer A LO to RF Leakage vs Frequency and Temperature

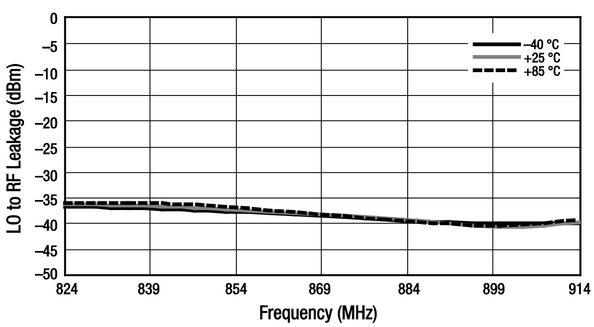


Figure 41. Mixer B LO to RF Leakage vs Frequency and Temperature

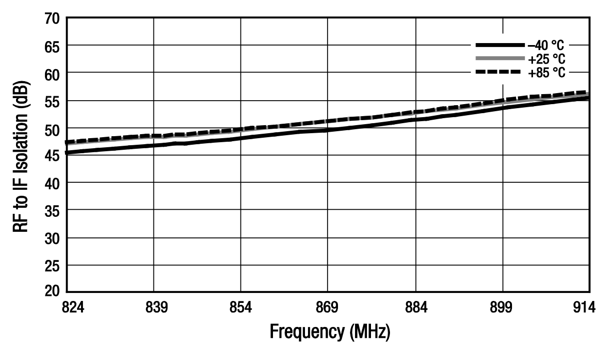


Figure 42. Mixer A RF to IF Isolation vs Frequency and Temperature

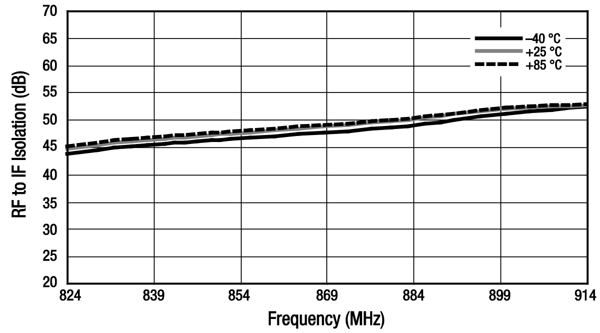


Figure 43.Mixer B RF to IF Isolation vs Frequency and Temperature

Evaluation Board Description

The SKY73087-11 Evaluation Board is used to test the performance of the SKY73087-11 downconversion mixer. An assembly drawing for the Evaluation Board is shown in Figure 44 and the layer detail is provided in Figure 45. A schematic diagram of the SKY73087-11 Evaluation Board is shown in Figure 46.

Circuit Design Considerations

The following design considerations are general in nature and must be followed regardless of final use or configuration:

1. Paths to ground should be made as short as possible.
2. The ground pad of the SKY73087-11 has special electrical and thermal grounding requirements. This pad is the main thermal conduit for heat dissipation. Since the circuit board acts as the heat sink, it must shunt as much heat as possible from the device. Therefore, design the connection to the ground pad to dissipate the maximum wattage produced by the circuit board.
3. Skyworks recommends including external bypass capacitors on the VCC voltage inputs of the device.
4. Components L5, L6, L14, and L15 (see Figure 46) are high-Q low loss inductors. These inductors must be able to pass currents in excess of 200 mA DC.
5. Components R1 and R2 (see Figure 46) set the bias current for the IF amplifiers. Skyworks recommends that these resistors have a tolerance of ±1% to optimize performance consistency of the SKY73087-11. These resistors are not required for the Evaluation Board to operate as specified in Tables 3 through 6.

Package Dimensions

The PCB layout footprint for the SKY73087-11 is provided in Figure 47. Figure 48 shows the package dimensions for the 36-pin MCM and Figure 49 provides the tape and reel dimensions.

Package and Handling Information

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

THE SKY73087-11 is rated to Moisture Sensitivity Level 3 (MSL3) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *PCB Design & SMT Assembly/Rework Guidelines for MCM-L Packages*, document number 101752.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

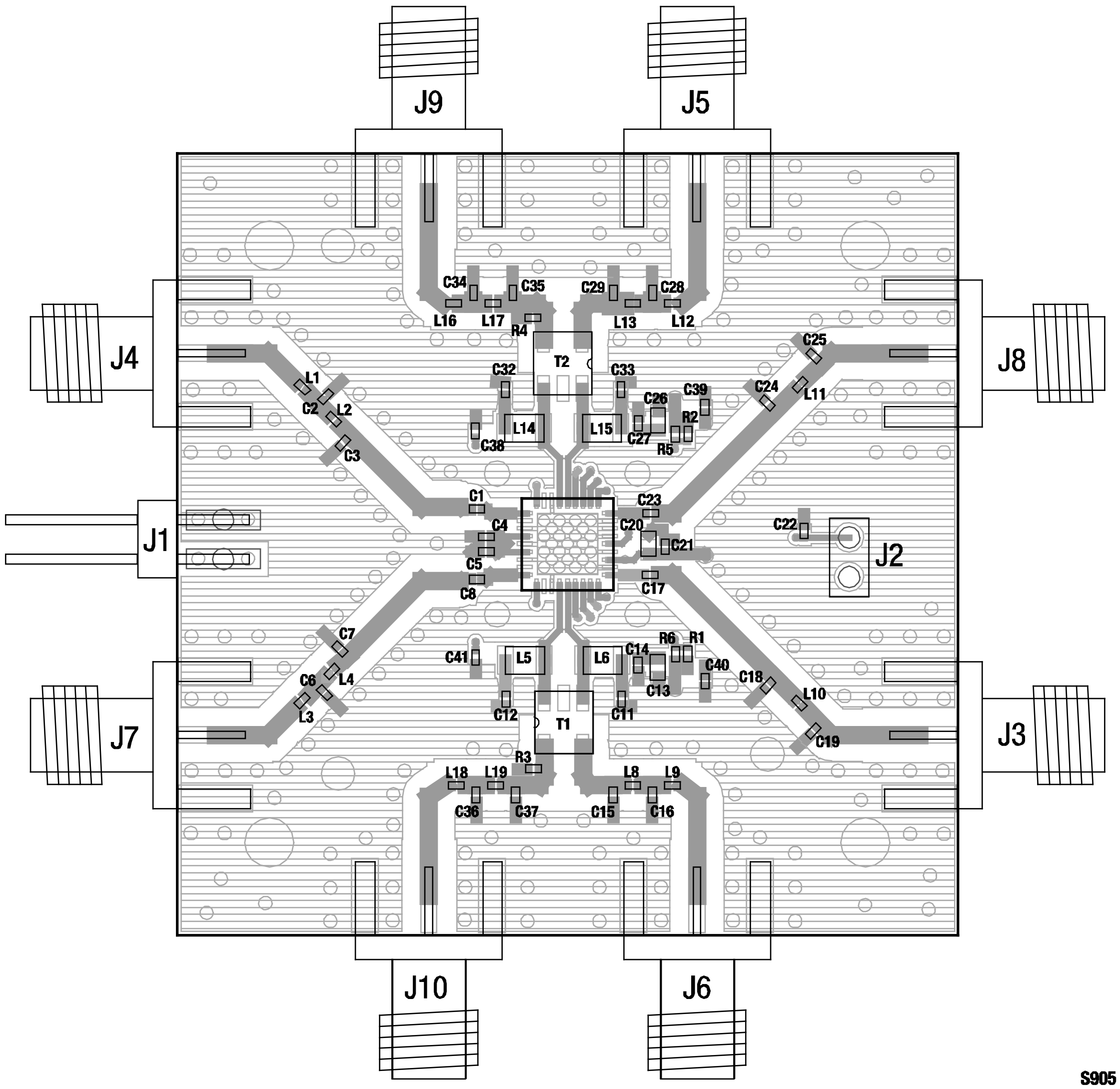
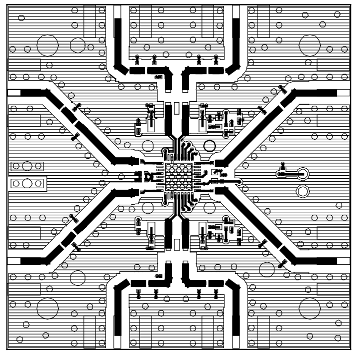
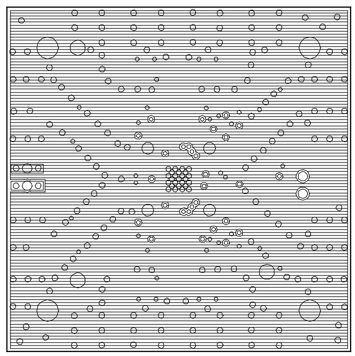


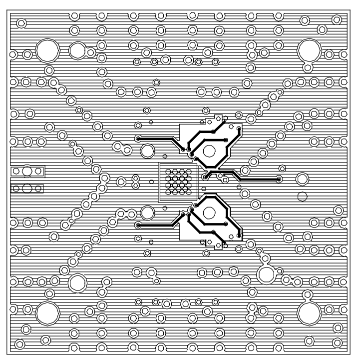
Figure 44. SKY73087-11 Evaluation Board Assembly Diagram



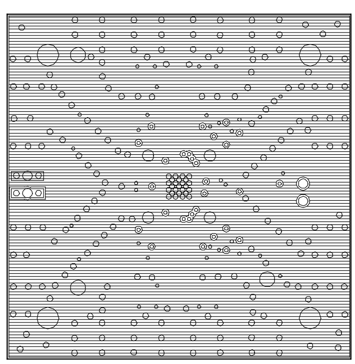
Layer 1: Top -- Metal



Layer 2: Ground



Layer 3: Power Plane



Layer 4: Solid Ground Plane

S904

Figure 45. SKY73087-11 Evaluation Board Layer Detail

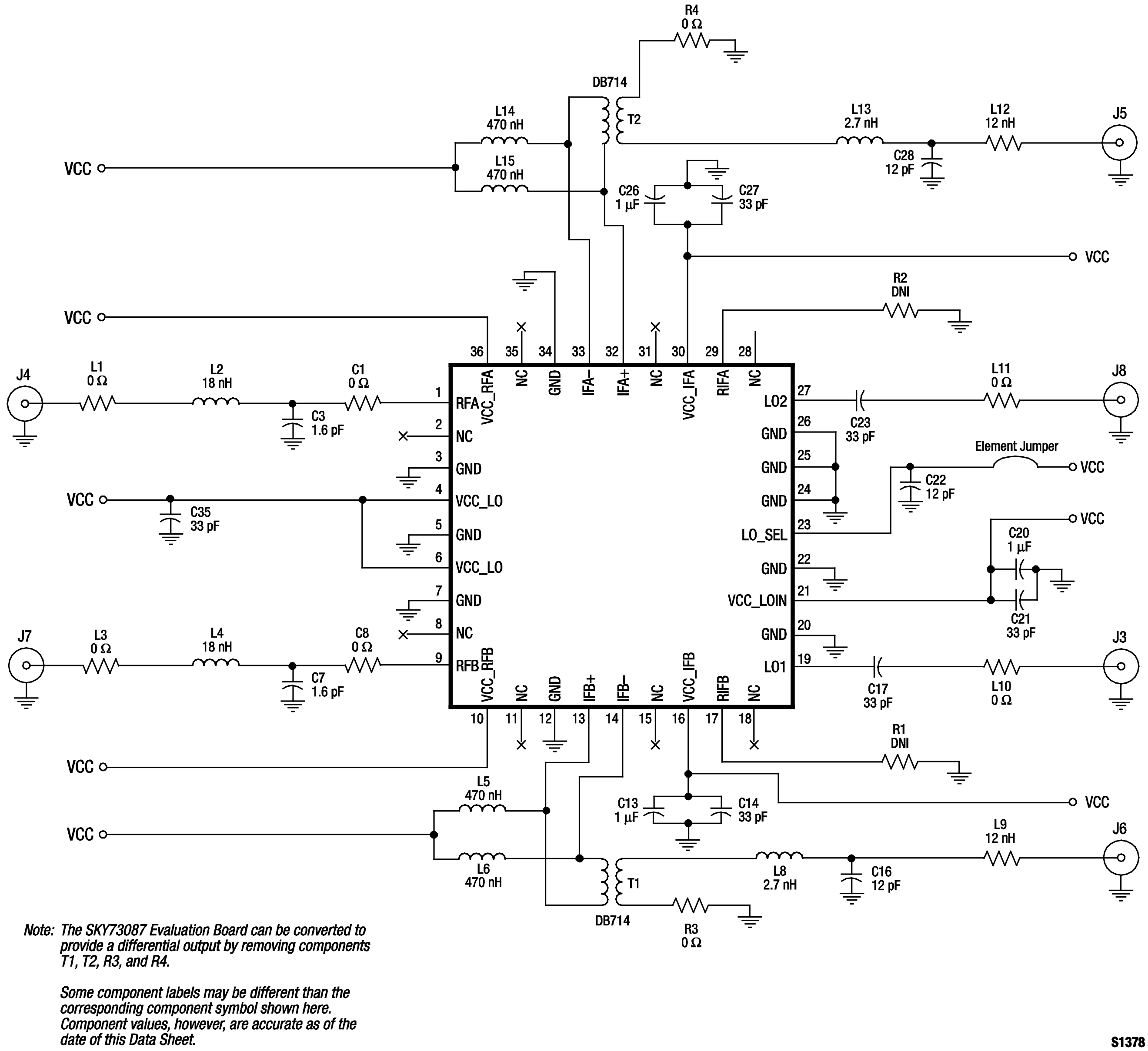
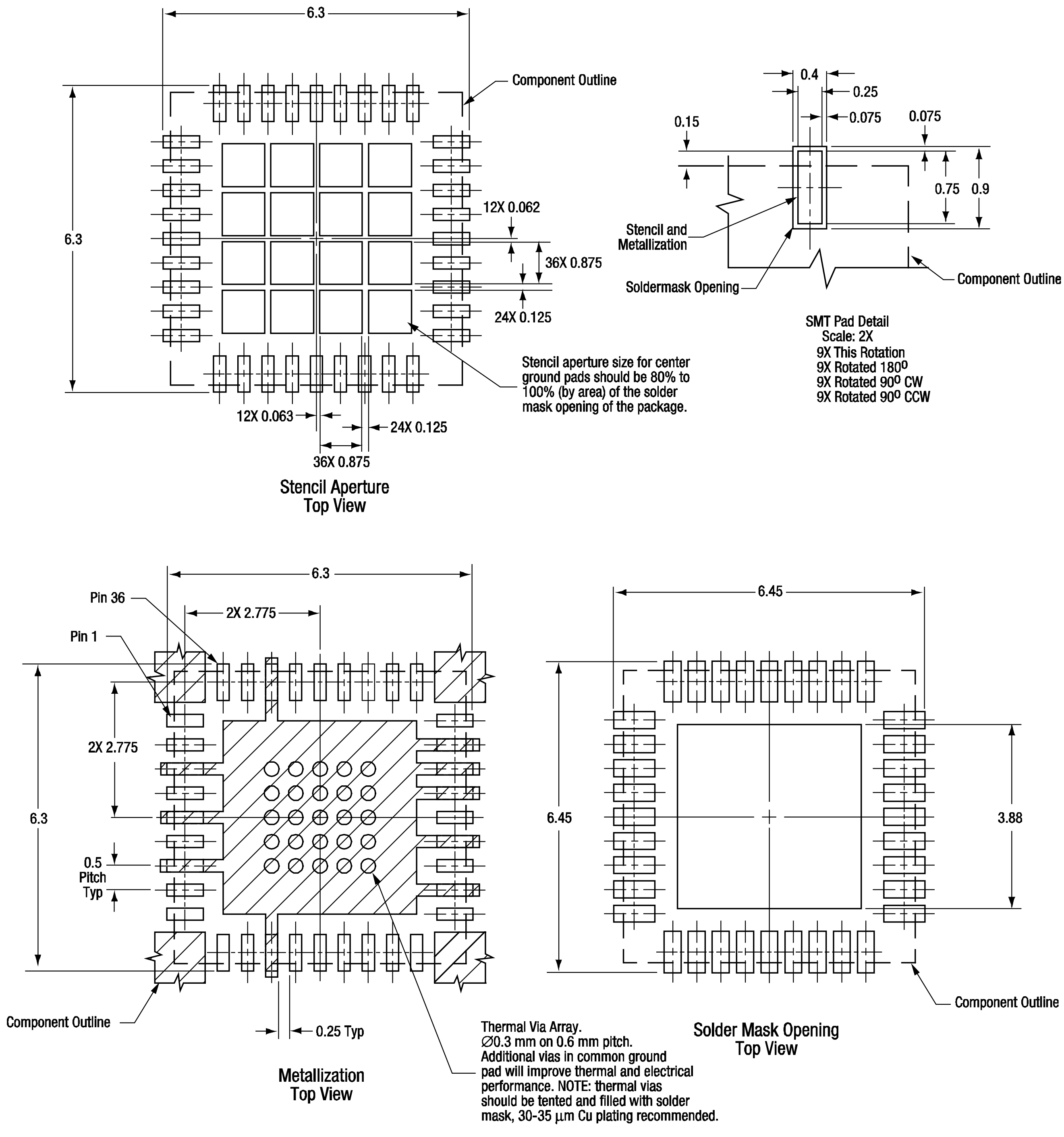


Figure 46. SKY73087-11 Evaluation Board Schematic



Note: The cross-hatched area represents the merger of the center ground pad +10 individual I/O ground pads. All I/O ground pads should have at least one via connected to internal ground planes for optimum electrical performance.

All measurements are in millimeters

S1125

Figure 47. PCB Layout Footprint for the SKY73087-11 6 x 6 mm MCM

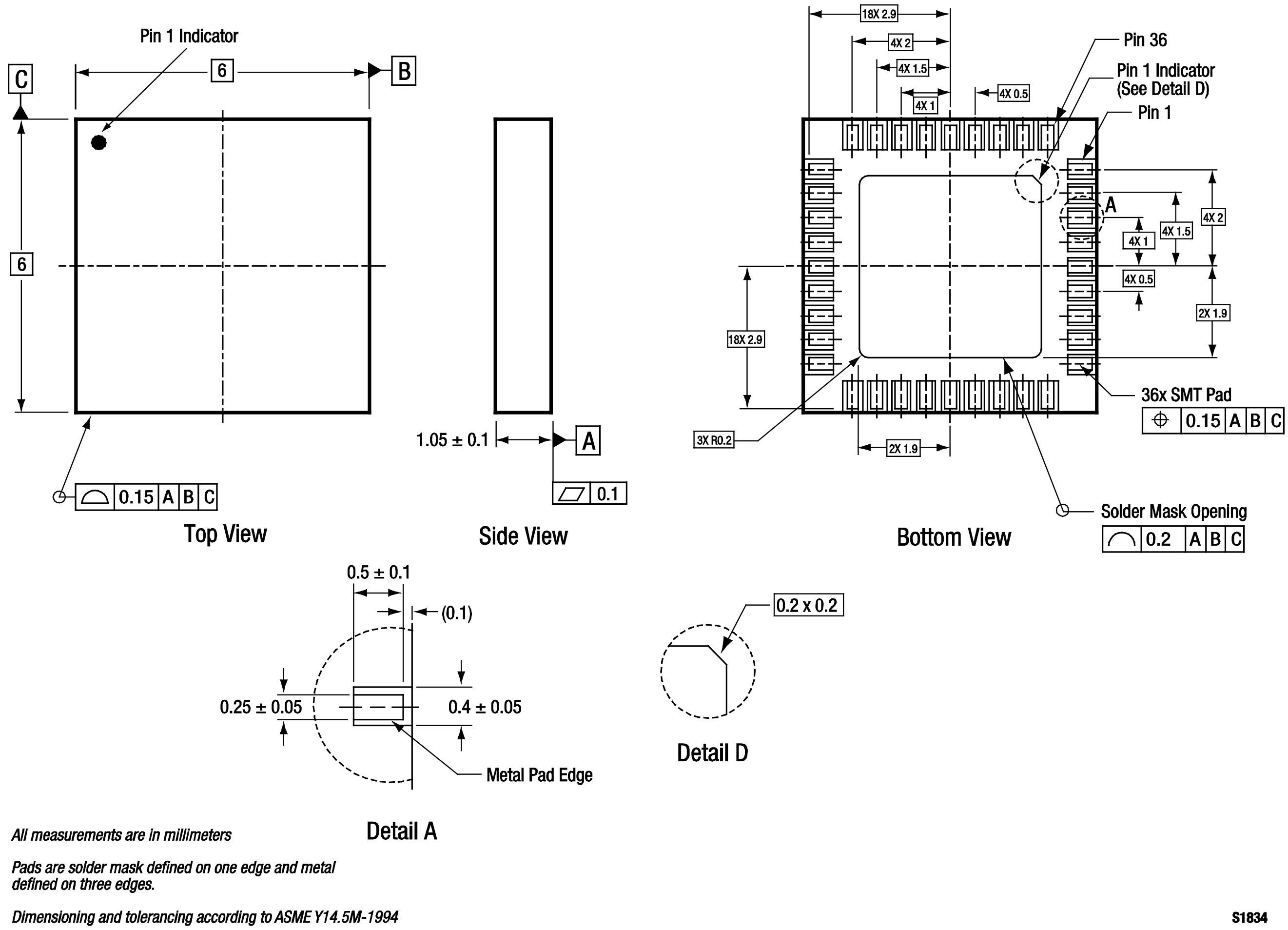
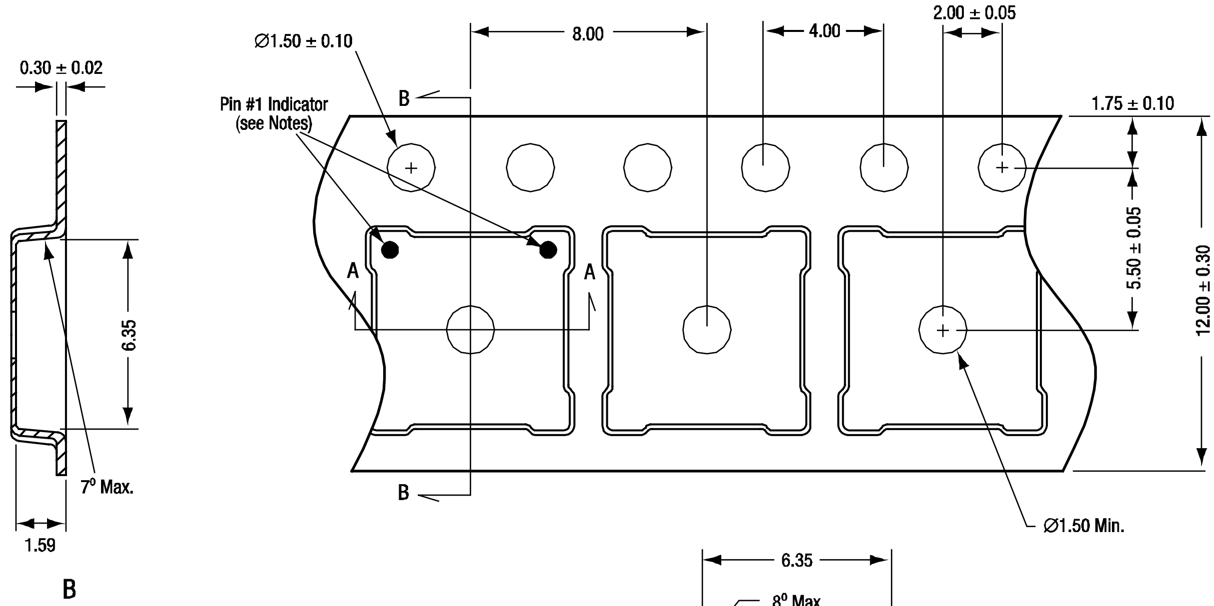
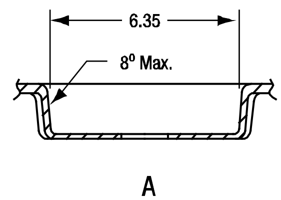


Figure 48. SKY73087-11 36-Pin MCM Package Dimensions





Notes:
1. *Carrier tape: black conductive polystyrene*
2. *Cover tape material: transparent conductive PSA*
3. *Cover tape size: 9.3 mm width*
4. *All dimensions are in millimeters*
5. *Pin 1 orientation is in top left corner for the following Skyworks products:*

   SKY73022-21, -31
   SKY73023-21, -31

   For all other 6 x 6 mm MCM/RFLGA products, pin 1 orientation is in top right corner.

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Figure 49. SKY73087-11 Tape and Reel Dimensions

Ordering Information

Model Name	Manufacturing Part Number	Evaluation Board Part Number
SKY73087-11 700-1000 MHz Downconversion Mixer	SKY73087-11	TW17-D870